

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Attorney Docket No.: CYPR-PM00005

JC864 U.S. PTO
09/635507
08/09/00

Inventor(s): Krishnaswamy Ramkumar, Kaichiu Wong and Venuka Jayatilaka

Serial No.:

Group Art Unit:

Filed: 08/09/00

Examiner:

Title: PROCESS FOR REDUCING LEAKAGE IN AN INTEGRATED CIRCUIT WITH SHALLOW TRENCH ISOLATED ACTIVE AREAS

The Commissioner of Patents and Trademarks
Washington, D.C. 20231
Sir:

Information Disclosure Statement Submitted Pursuant to 37 C.F.R. 1.97(b)

The citations referenced herein, copies attached, may be material to the examination of the above-identified application and are, therefore, submitted in compliance with the duty of disclosure as defined in 37 C.F.R. 1.56. The Examiner is requested to make these citations of official record in the application.

This Information Disclosure Statement submitted in accordance with 37 C.F.R. 1.97(b) is not to be construed as a representation that a search has been made, that additional items material to the examination of this application do not exist, or that any one or more of these citations constitute prior art under 35 U.S.C. 102.

The Examiner's attention is respectfully directed to the following U.S. Patents:

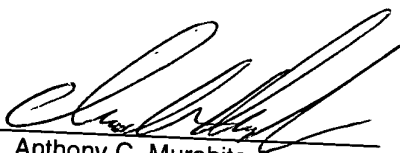
Pat. No.	Pat. Title	Grant Date
5,468,676	TRENCH ISOLATIONS STRUCTURE AND METHOD FOR FORMING	11/21/95
5,858,858	ANNEALING METHODS FOR FORMING ISOLATION TRENCHES	01/12/99
5,910,018	TRENCH EDGE ROUNDING METHOD AND STRUCTURE FOR	06/08/99
5,950,096	TRENCH ISOLATION	
5,960,299	PROCESS FOR IMPROVING DEVICE YIELD IN INTEGRATED	09/08/99
5,994,178	CIRCUIT FABRICATION	
6,001,706	METHOD OF FABRICATING A SHALLOW-TRENCH ISOLATION	09/28/99
6,004,864	STRUCTURE IN INTEGRATED CIRCUIT	
6,005,279	METHOD OF FABRICATING CMOS TRANSISTORS WITH A PLANAR	11/30/99
6,013,561	SHALLOW TRENCH ISOLATION	
6,020,251	METHOD FOR MAKING IMPROVED SHALLOW TRENCH ISOLATION	12/14/99
6,033,968	FOR SEMICONDUCTOR INTEGRATED CIRCUITS	
6,037,018	ION IMPLANT METHOD FOR INTEGRATED CIRCUIT DEVICES	12/21/99
	TRENCH EDGE SPACER FORMATION	12/21/99
	METHOD FOR FORMING FIELD OXIDE FILM OF SEMICONDUCTOR	01/11/00
	DEVICE	
	METHOD OF FORMING BURIED DIFFUSION JUNCTIONS IN	02/01/00
	CONJUNCTION WITH SHALLOW-TRENCH ISOLATION	
	STRUCTURES IN A SEMICONDUCTOR DEVICE	
	METHOD FOR FORMING A SHALLOW TRENCH ISOLATION	03/07/00
	STRUCTURE	
	SHALLOW TRENCH ISOLATION FILLED BY HIGH DENSITY PLASMA	03/14/00
	CHEMICAL VAPOR DEPOSITION	

Please direct all correspondence concerning the above-identified application to the following address:

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Respectfully submitted,

Date: 8/9/2000

By: 
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